

# Using the TPS2458EVM

## User's Guide



Literature Number: SLUU348A  
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# **TPS2458 ATCA™ AdvancedMC™ Controller**

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## **1 Introduction**

The AdvancedMC™ Controller Evaluation Module (EVM) is a PCB platform for users to learn about the features and operation of the TPS2458 integrated circuit (IC) from Texas Instruments (TI). The TPS2458 ATCA™ AdvancedMC™ Controller IC manages a 12-V and a 3.3-V power rail and features inrush and fault current limiting, FET OR'ing, input UVLO protection and logic-level enable inputs. Current control on the 12-V rail has a high degree of programmability, including independent current limit and fast trip thresholds. Overcurrent fault timing is managed with user-programmable shut-down delays, and each of the two power channels has dedicated fault and power good reporting outputs. In addition, current sense and pass and block FET's for the 3.3-V channel is fully integrated into the device.

Power management applications based on the TPS2458 are easily configured to meet the requirements for 12-V and 3.3-V control of Advanced Mezzanine Card (AdvancedMC™) modules. Each device incorporated onto a Carrier Card provides full control for an AdvancedMC™ slot according to the requirements of the Advanced Telecommunications Computing Architecture (ATCA™) specification, PICMG 3.0.

## **2 Description**

### **2.1 Module Overview**

The TPS2458EVM is a single-board evaluation platform consisting of two main sections. When oriented with the board nomenclature and switch labels in a normal, upright reading position towards the user, the top portion contains the TPS2458 IC and typically required components. The bottom section contains more ancillary circuitry intended to facilitate exercising the device through various application scenarios. Power connectors are organized with inputs along the left edge of the board, outputs along the right.

The main (upper) section of the board is comprised of the two power channels, including the featured device, support passives, input and output banana jacks, control FET's (for 12-V rail), and power planes. The board contains various capacitors for simulation of input bulk capacitance as may be present on driven AdvancedMC™ modules; alternatively, the user's test loads can be connected at the output banana jacks. Various timing capacitor options, for each power rail, are available and user-selectable via DIP switch S4. Numerous jumpers are provided throughout the circuit for maximum configuration flexibility. Test points are available for voltage and waveform monitoring.

The bottom section contains expansion port connectors and the status LED's. Slide switches for actuation of the chip enable inputs are organized in a row along the bottom edge of the PCB.

## 2.2 Features

The TPS2458EVM includes the following features:

- One TPS2458 ATCA™ AdvancedMC™ Controller IC
- Programming and sense resistors (12-V)
- Low  $R_{DS(ON)}$  pass and block FET's (12-V)
- Input and output power jacks for external supply and optional load connection
- up to 880  $\mu\text{F}$  ( $4 \times 220 \mu\text{F}$ ) jumpered load capacitors (12-V channel) for simulated Payload Power output bulk capacitance
- 150  $\mu\text{F}$  jumpered load capacitor for the Management Power channel
- Multiple, switch-selectable fault timer settings, each channel
- Slide switch actuation of enable inputs
- Expansion port headers

The use of these features is described in greater detail later in this document.

## 3 Electrical Specifications

### 3.1 Absolute Maximum Ratings

The absolute maximum ratings for the TPS2458EVM are given in [Table 1](#).

**Table 1. Absolute Maximum Ratings<sup>(1)(2)</sup>**

	RATING	UNIT
Input voltage range, 12-V supply	-0.3 to 13.8	V
Input voltage range, 3.3-V supply	-0.3 to 4	
Applied voltage, pins of J21, J22 $\overline{\text{EN}}12\text{x}$ , $\overline{\text{OREN}}\text{x}$	-0.3 to $(V_{IN}(12V\text{INx}) + 0.5)$	
Applied voltage, pins of J21, J22 SUMx, $\overline{\text{EN}}3\text{x}$	-0.3 to $(V_{IN}(3V3\text{INx}) + 0.5)$	
Output current, 12-V outputs	10	A
Output current, 3.3-V outputs	Internally limited by device	
Output current, SUMx	-5	mA
Storage temperature range	-55 to 150	°C

(1) All voltages are with respect to the EVM GND node.

(2) Currents are positive into and negative out of the specified terminal.

### 3.2 Recommended Operating Conditions

The recommended operating conditions for the TPS2458EVM are given in [Table 2](#).

**Table 2. Recommended Operating Conditions, TPS2458EVM<sup>(1)(2)</sup>**

	MIN	TYP	MAX	UNITS
Input supply voltage, 12 V	8.8	12	13.2	V
Input supply voltage, 12 V (for specified $V_{OUT}$ )	11.3	12	13.2	
Input supply voltage, 3.3 V	2.85	3.3	3.5	
Input supply voltage, 3.3 V (for specified $V_{OUT}$ )	3.235	3.3	3.465	
Load current, payload power out (either channel)			-7.4	A
Load current, management power out (either channel)			-165	mA

(1) All voltages are with respect to the EVM GND node.

(2) Currents are positive into and negative out of the specified terminal.

### 4 Schematic Diagrams

The schematic diagrams for the TPS2458EVM is shown in [Figure 1](#).

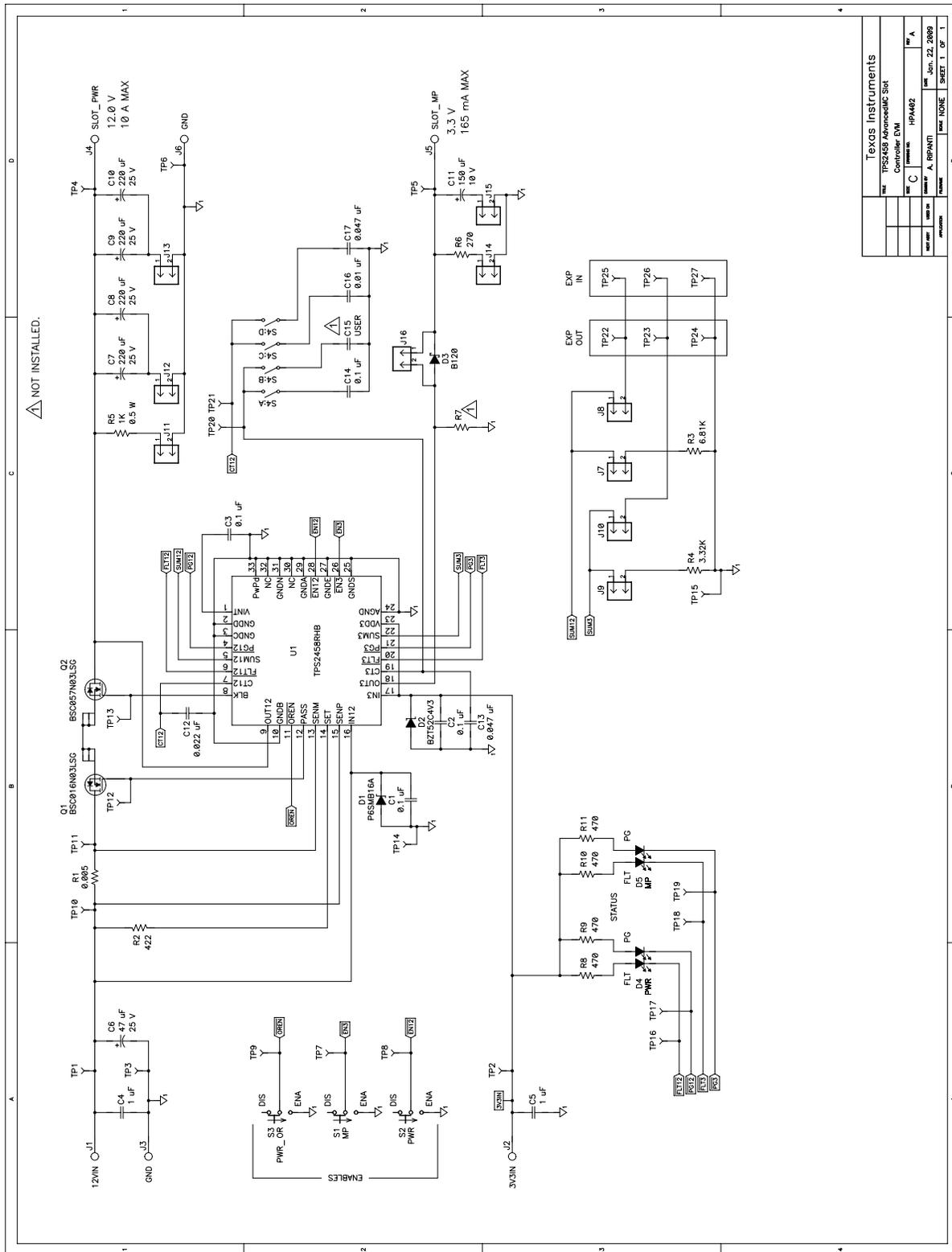


Figure 1. TPS2458 Evaluation Module Schematic Diagram

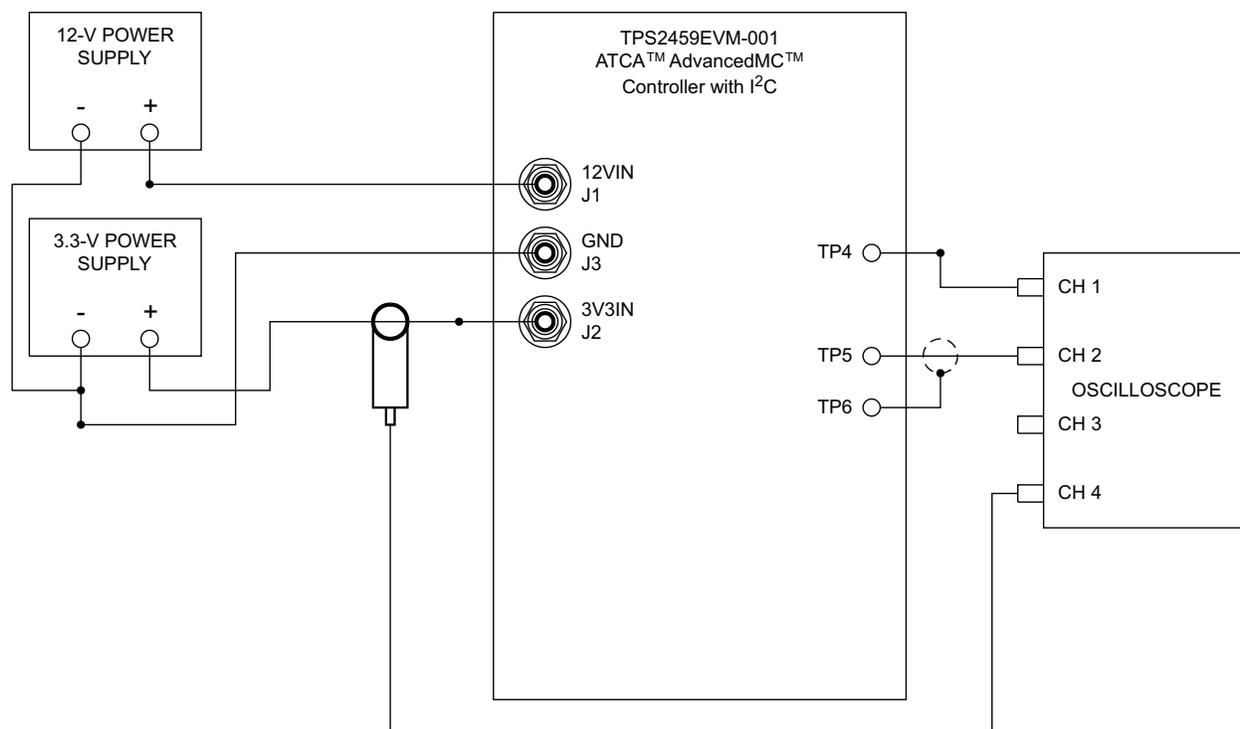
## 5 Test Set-Up

### 5.1 Equipment Requirement

The following test and interface equipment (not supplied) is required to verify EVM module operation, and begin using the EVM.

- Power supply, 3.3 VDC, 500 mA minimum
- Power supply, 15 VDC, 10 A minimum
- Digital multimeters
- Oscilloscope, 4 channel, with current probe

Connect the TPS2458EVM and test equipment as shown in [Figure 2](#) for functional check-out of the board and a good starting point for user evaluation of device operation. Screen print labeling on the board employs a naming convention in keeping with the nomenclature of the target ATCA™ and MicroTCA™ applications. Input 3.3-V supply is connected to the 3V3IN jack, and the 12-V supply is connected to the 12VIN jack. A cross-reference of power rail labeling to standards naming is shown in [Table 3](#).



**Figure 2. Connection Diagram**

**Note:** Run separate leads from the GND jacks back to a common return point made near the power supply output terminals.

**Table 3. TPS2458EVM Output Net and Jack Naming**

REF DES	CONNECTOR LABEL	DESCRIPTION
J4	SLOT PWR	AdvancedMC™ Slot Payload Power
J5	SLOT MP	AdvancedMC™ Slot Management Power
J6	GND	Common load return node

## 5.2 Jumper Installation

The TPS2458EVM makes use of various jumpers for quick change of functional configurations. Verify the module was supplied with shunt jumpers installed across the headers listed in [Table 4](#). For 3-pin headers, note the pin pairs to be connected. Reconfigure jumper connections if necessary.

**Table 4. Initial Jumper Settings**

SIGNAL AND CONTROL JUMPERS
J7, J9
J11–J16

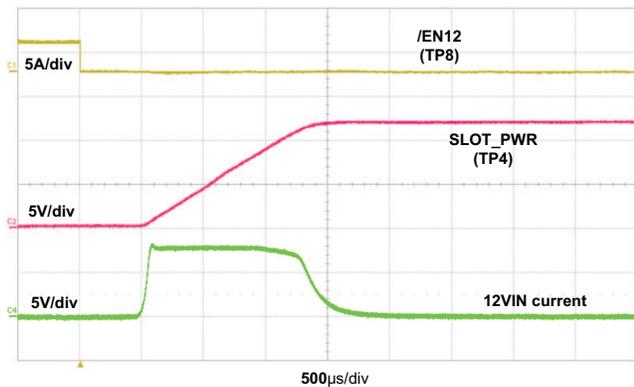
On the EVM board, place the ENABLE slide switches, located along the bottom edge of the PCB, in the initial positions shown in [Table 5](#).

**Table 5. ENABLE Switch Initial Positions**

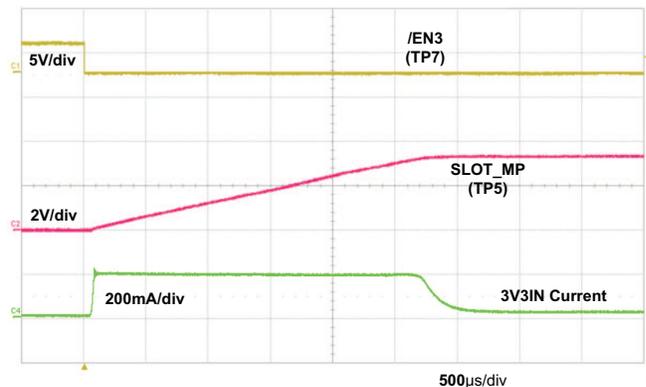
SECTION	SWITCH NAME	INITIAL POSITION
SLOT	MP	DIS
	PWR	DIS
	PWR_OR	ENA

Set all 4 DIP positions of switch S4 to the CLOSED position.

## 5.3 Test Results



**Figure 3. Output Ramp-Up Waveforms – SLOT\_PWR Rail**



**Figure 4. Output Ramp-Up Waveforms – SLOT\_MP Rail**

## 6 EVM Feature Details

### 6.1 Test Points

The TPS2458EVM contains numerous test points throughout the circuit for user monitoring of waveforms and voltage measurement. Table 6 lists the module test points and the signal available at each one. The EVM PCB layout connects all ground nodes and supply returns to a common GND node, via several power plane areas. However, due to potentially high loading conditions on the two Payload Power outputs, multiple ground test points are provided to mitigate the measurement impact of return current drops. Therefore, where appropriate, certain test points are paired in the table with the pertinent reference point for meter return connections

**Table 6. Module Test Points**

TEST POINT NAME	REF. POINT	SIGNAL NAME	DESCRIPTION
TP1	TP3	12VIN	Input 12 V supply for AdvancedMC™ Slot A
TP2		3V3IN	Input 3.3 V supply for AdvancedMC™ Slot A
TP4	TP6	SLOT_PWR	AdvancedMC™ Payload Power, 12 V output
TP5		SLOT_MP	AdvancedMC™ Management Power, 3.3 V output
TP7	TP27	$\overline{\text{EN3}}$	Active-low enable input to TPS2458 for the 3.3 V rail
TP8		$\overline{\text{EN12}}$	Active-low enable input to the TPS2458 for the 12-V rail
TP9		$\overline{\text{OREN}}$	Channel A OR'ing FET/function enable signal to the TPS2458
TP10	TP11		12-V load current sense voltage
TP12	TP14	PASS	TPS2458 pass FET gate drive output
TP13		BLK	TPS2458 block/OR'ing FET gate drive output
TP16	TP15 TP24 TP27	$\overline{\text{FLT12}}$	Slot A 12-V open-drain, active-low FAULT output indication
TP17		$\overline{\text{PG12}}$	Slot A 12-V open-drain, active-low POWERGOOD output indication
TP18		$\overline{\text{FLT3}}$	Slot A 3.3-V open-drain, active-low FAULT output indication
TP19		$\overline{\text{PG3}}$	Slot A 3.3-V open-drain, active-low POWERGOOD output indication
TP20	TP14	CT3	Timing cap waveform for the 3.3-V rail (SLOT_MP)
TP21		CT12	Timing cap waveform for the 12-V rail (SLOT_PWR)
TP22	TP15 TP24 TP27	SUM12OUT	Expansion current summing output 12.0 V
TP23		SUM3OUT	Expansion current summing output 3.3 V
TP25		SUM12IN	Expansion current summing input 12.0 V
TP26		SUM3IN	Expansion current summing input 3.3 V

On the TPS2458EVM, the device fault ( $\overline{\text{FLT}}_x$ ) and power good ( $\overline{\text{PG}}_x$ ) outputs are all used to drive the STATUS LED's. Power for LED drive is derived from the 3.3-V input supply.

## 6.2 Connecting Loads to the TPS2458EVM

Each of the power rails of the TPS2458EVM is supplied with some amount of load capacitance in the form of discrete electrolytics. The capacitors can be connected to or disconnected from their associated output nodes using 100-mil, 2-pin shunt jumpers across the on-board PCB headers. These capacitors are intended to simulate input bulk capacitance which may be encountered at the front ends of AdvancedMC™ modules plugged into the card slots of the target application. The AdvancedMC™ standard specifies the maximum allowable input capacitance on both Management and Payload Power rails. The TPS2458EVM provides up to 150  $\mu$ F capacitance on the Management Power output, according to the AdvancedMC™ maximum limit. The EVM also provides up to 880  $\mu$ F of capacitance, implemented in increments of 440  $\mu$ F devices, on the Payload Power rail, to approximate the 800  $\mu$ F limit of the standard. In addition, low-level (mA) load resistors can be jumpered in across each output and return. These limited load resistors are intended primarily as reset devices between output ramp events, particularly when loaded with significant capacitance.

[Table 7](#) lists the EVM module's output voltage nodes, and for each one indicates the associated jumper reference designators, and the resultant load value with jumper installed.

**Table 7. EVM On-Board Loads**

OUTPUT RAIL	JUMPER	DEVICE	VALUE
SLOT_MP	J15	C11	150 $\mu$ F
	J14	R6	270 $\Omega$
SLOT_PWR	J12	C7, C8	440 $\mu$ F
	J13	C9, C10	440 $\mu$ F
	J11	R5	1 k $\Omega$

Banana jacks are provided along the right-hand edge of the board for connection of the user's optional test loads. The output banana jack reference designators are listed in [Table 3](#) along with the voltage rail available at each one. Also, the net names are screen printed on the PCB, adjacent to their respective jacks.

## 7 Assembly Drawing and PCB Layout

The top assembly drawing and individual PCB layers for the TPS2458EVM are shown in the following figures.

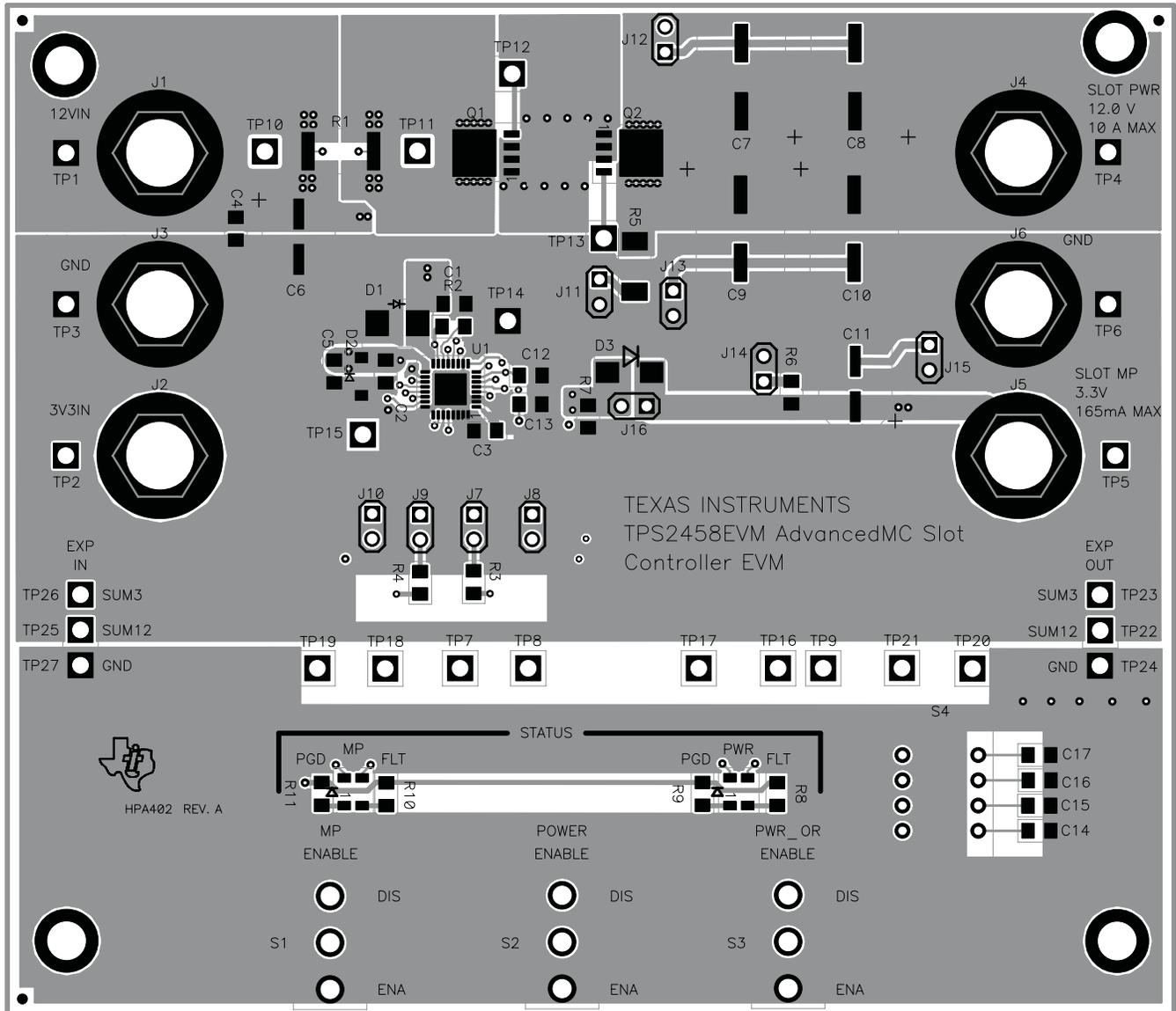


Figure 5. Top Assembly

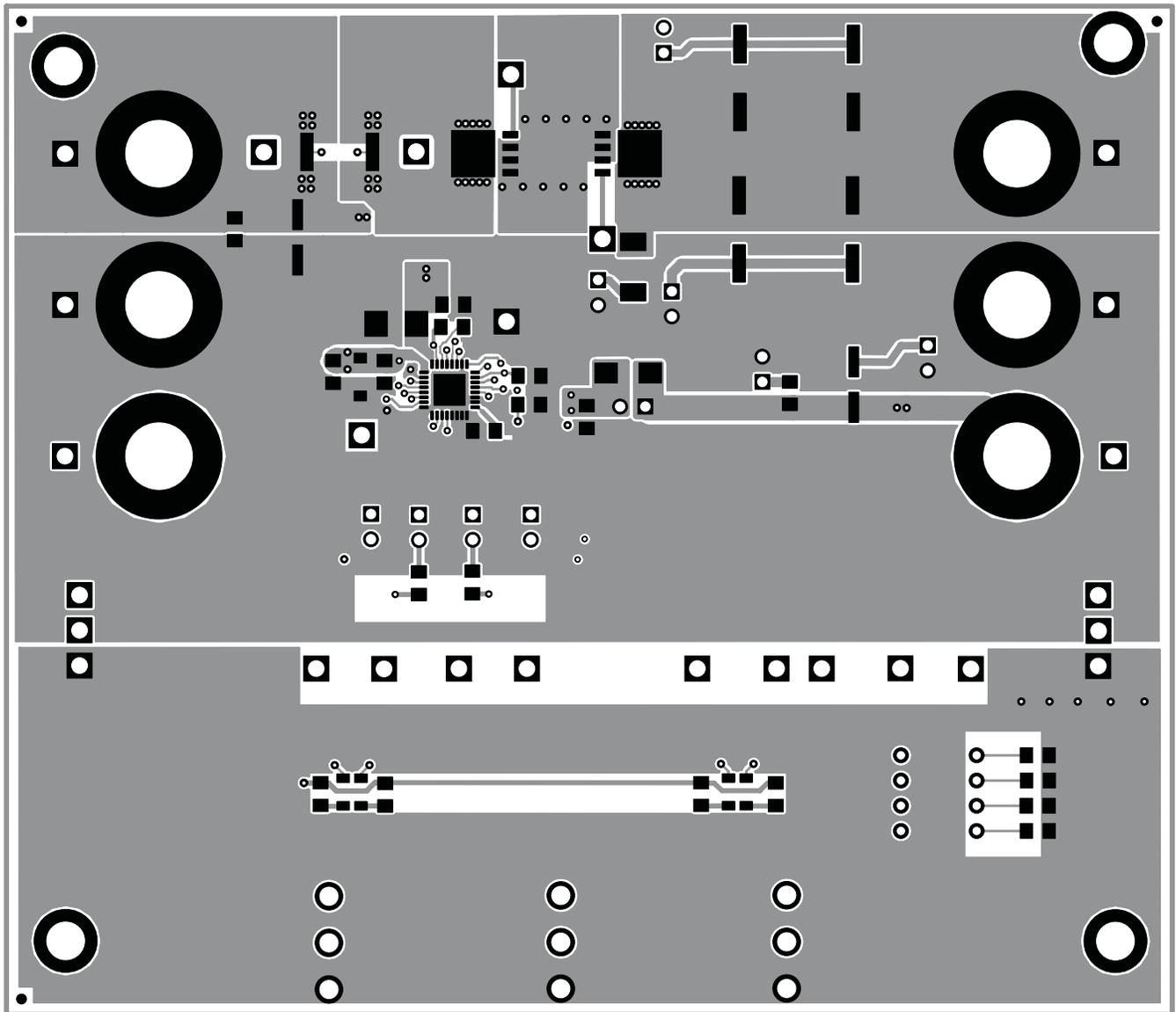


Figure 6. Top Layer Routing

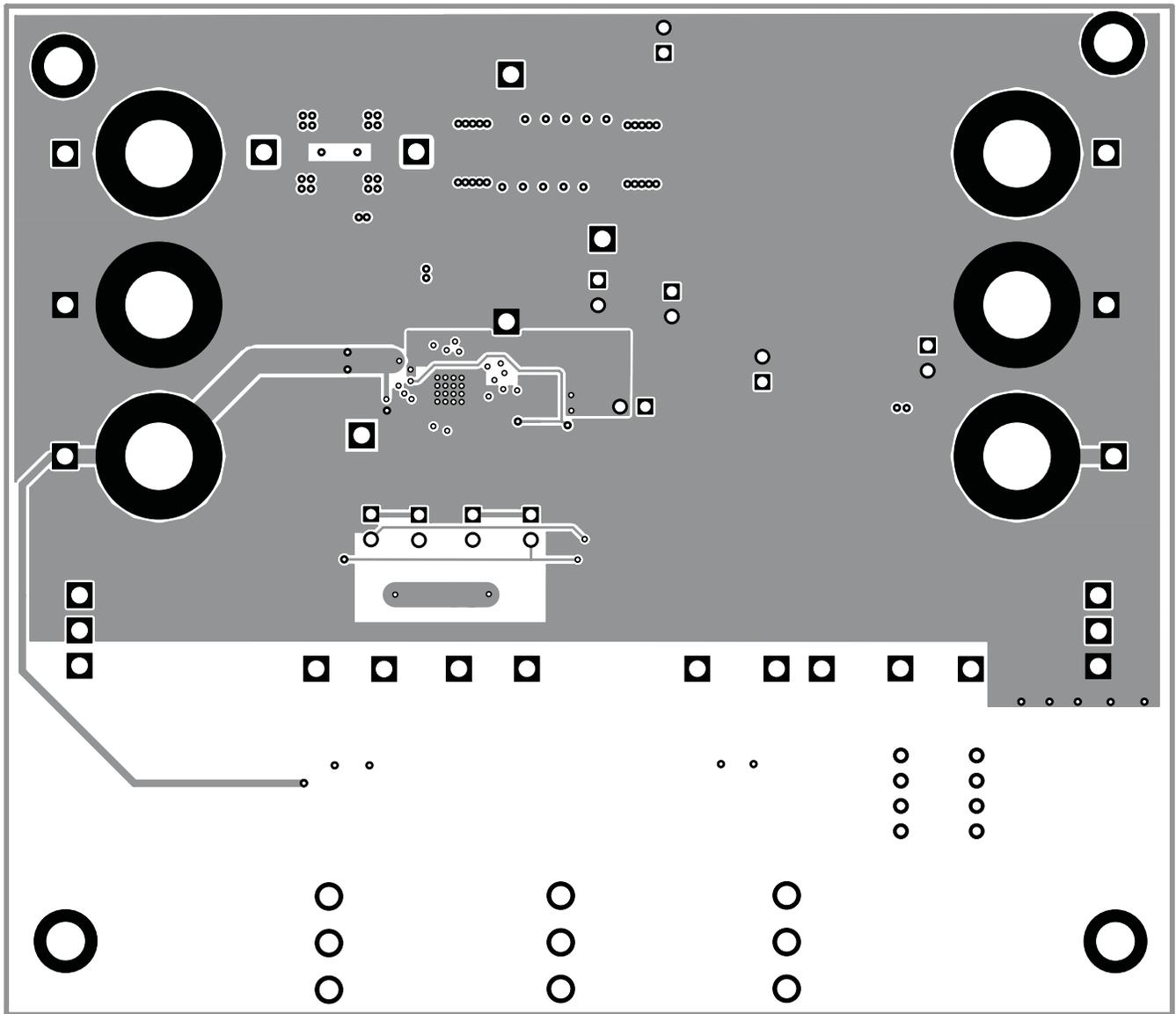


Figure 7. Layer 2 Routing

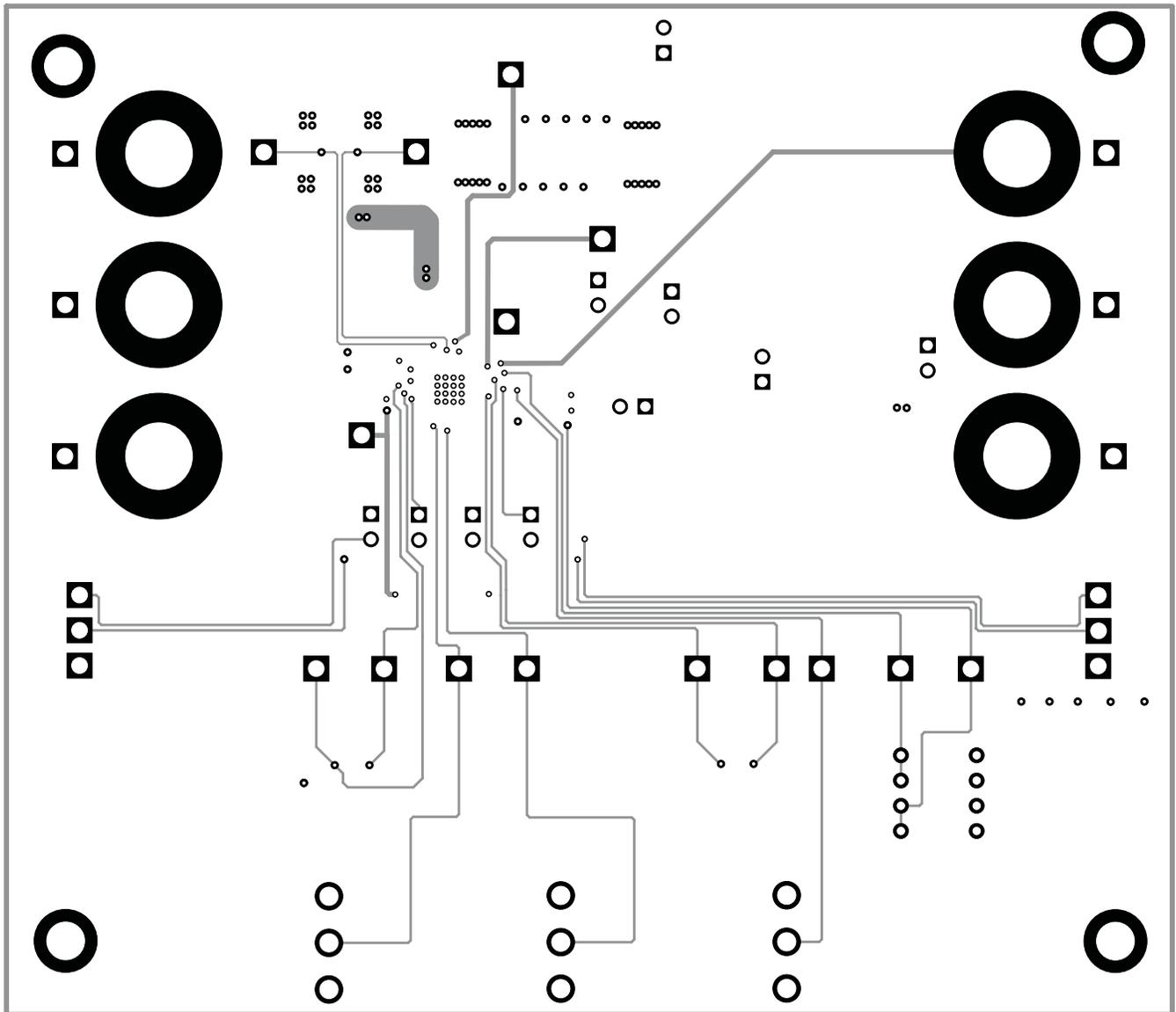


Figure 8. Layer 3 Routing

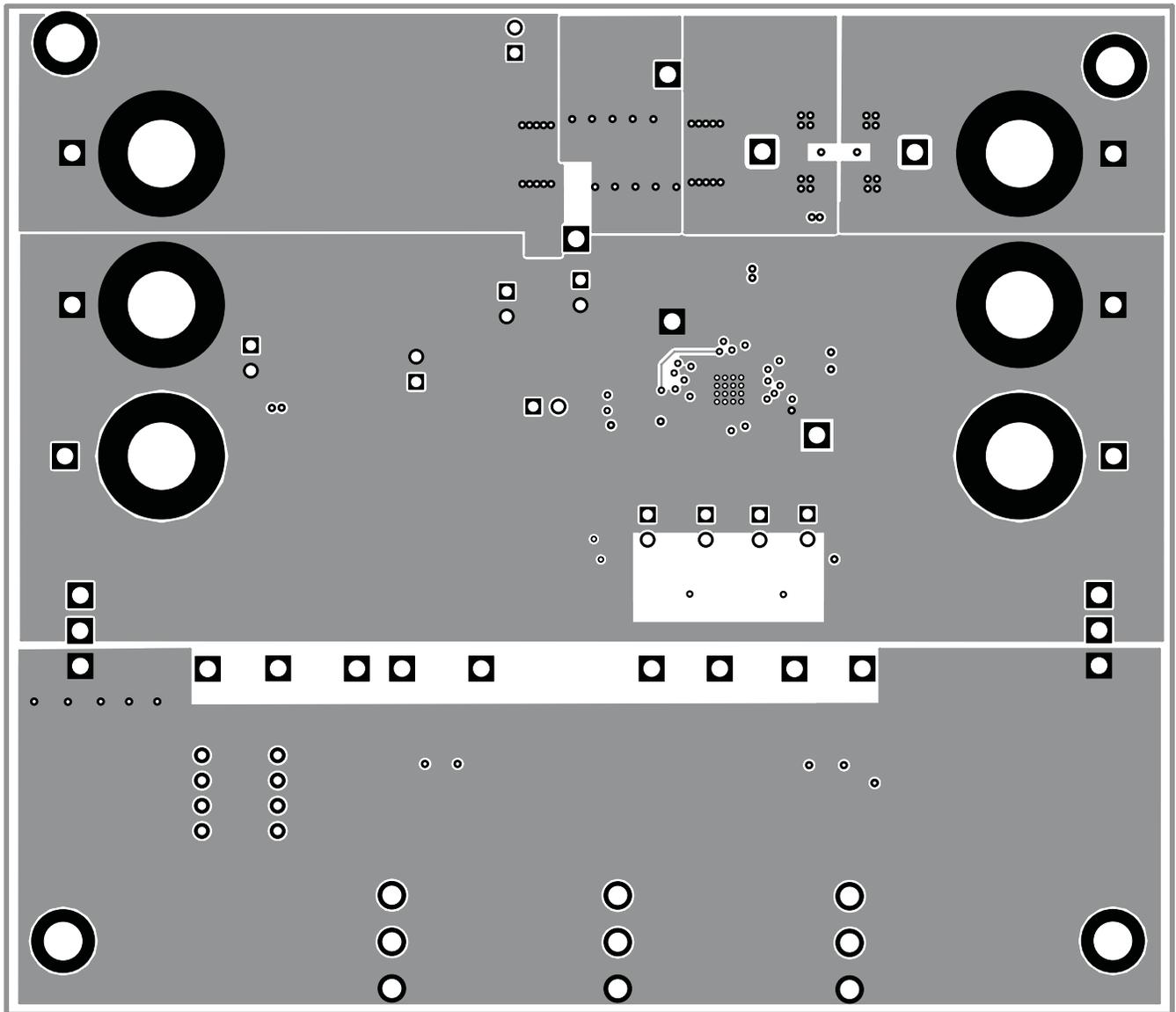


Figure 9. Bottom Layer Routing

## 8 List of Materials

**Table 8. TPS2348 List of Materials<sup>(1)(2)(3)(4)(5)(6)(7)(8)(9)</sup>**

COUNT	REF DES	DESCRIPTION	PART NUMBER	MFR
3	C1, C2, C3	Capacitor, ceramic, 25 V, X7R, 20%, 0.1 $\mu$ F, 0805	Std.	Std.
1	C11	Capacitor, aluminum, SM, 10 V, $\pm$ 20%, 150 $\mu$ F, case D	EEV-FK1A151P	Panasonic
1	C12	Capacitor, ceramic, 10 V, X7R, 10%, 0.022 $\mu$ F, 0805	Std.	Std.
2	C13, C17	Capacitor, ceramic, 10 V, X7R, 10%, 0.047 $\mu$ F, 0805	Std.	Std.
1	C14	Capacitor, ceramic, 10 V, X7R, 10%, 0.1 $\mu$ F, 0805	Std.	Std.
0	C15	Capacitor, ceramic, 10 V, X7R, 10%, 0805	Std.	Std.
1	C16	Capacitor, ceramic, 10 V, X7R, 10%, 0.01 $\mu$ F, 0805	Std.	Std.
2	C4, C5	Capacitor, ceramic, 25 V, X7R, 20%, 1 $\mu$ F, 0805	Std.	Std.
1	C6	Capacitor, aluminum, SM, 25 V, $\pm$ 20%, 47 $\mu$ F, Case D	EEV-FK1E470P	Panasonic
4	C7, C8, C9, C10	Capacitor, aluminum, SM, 25 V, $\pm$ 20%, 220 $\mu$ F, Case F	EEV-FK1E221P	Panasonic
1	D1	Diode, TVS, V(RWM) = 13.6 V, 600 W pk., SMB	P6SMB16A	"ON Semior Vishayor Littelfuse"
1	D2	Diode, Zener, 4.3 V, 500 mW max., SOD-123	BZT52C4V3	Diodes
1	D3	Diode, Schottky, 1 A, 20 V, SMA	B120	Diodes
2	D4, D5	Diode, LED, red/green, 1210, 45/35 mcd @ 20 mA, 0.126 x 0.106in.	LTST-C155KGJRKT	Lite-On
6	J1, J2, J3, J4, J5, J6	Jack, banana, non-ins., PC mount, TH	3267	Pomona
10	J7, J8, J9, J10, J11, J12, J13, J14, J15, J16	Header, 2 pin, 100-mil spacing, 0.100 in. x 2	PEC36SAAN	Sullins
1	Q1	Transistor, NFET, 30 V, 100A, $R_{DS(on)} < 5$ mohm, TDSO-8	"BSC016N03LSG# #or BSC022N03SG"	Infineon
1	Q2	Transistor, NFET, 30 V, $R_{DS(on)} < 20$ mohm, TDSO-8	"BSC057N03LSG# #or BSC050N03LSGor BSC042N03LSGor BSC022N03SGor BSC016N03LSG"	Infineon

- (1) These assemblies are ESD sensitive, ESD precautions shall be observed.
- (2) These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- (3) These assemblies must comply with workmanship standards IPC-A-610 Class 2.
- (4) "TH" package designation indicates "thru-hole" (lead) component.
- (5) Part number information is for reference only to further illustrate component characteristics; substitution of other mfgs' part of equal or better specification is permissible. Substitution NOT allowed on part numbers marked with double asterisk (\*\*).
- (6) Double pound sign ("##") after part number indicates preferred device. Acceptable substitutes are listed afterwards, in decreasing order of preference.
- (7) If banana jacks (J1 - J6) are supplied with solder lugs, dispose of lugs prior to installation on PCB. Solder lugs are NOT to be installed on assembly.
- (8) Spacers to be installed at each of the thru-holes at the four corners of the PCB assembly, using nylon screws.
- (9) Shunts installed in accordance with manufacturing test procedure during test.

**Table 8. TPS2348 List of Materials (continued)**

COUNT	REF DES	DESCRIPTION	PART NUMBER	MFR
1	R1	Resistor, metal strip, 1 W, 1%, 0.005 $\Omega$ , 2512	WSL2512-5L000FEA	Vishay-Dale
1	R2	Resistor, chip, 1/10 W, 1%, 422 $\Omega$ , 0805	Std	Std
1	R3	Resistor, chip, 1/10 W, 1%, 6.81 k $\Omega$ , 0805	Std	Std
1	R4	Resistor, chip, 1/10 W, 1%, 3.32 k $\Omega$ , 0805	Std	Std
1	R5	Resistor, chip, 1/2 W, 5%, 1 k $\Omega$ , 2010	Std	Std
1	R6	Resistor, chip, 1/10 W, 5%, 270 $\Omega$ , 0805	Std	Std
0	R7	Resistor, chip, 1/10 W, 5%, 0805	Std	Std
4	R8, R9, R10, R11	Resistor, chip, 1/10 W, 5%, 470 $\Omega$ , 0805	Std.	Std.
3	S1, S2, S3	Switch, slide, SPDT, vert. act., PC mount, 0.500 x 0.260 in.	"1101M2S3CBE2or 1101M2S3CKE2or 1101M2S3CQE2"	C&K Switch
1	S4	Switch, DIP, 4 pos., raised rocker, 0.38 x 0.48 inch	"76SB04S(T)or BD04"	"Grayhillor C&K Switch"
21	TP1, TP2, TP4, TP5, TP7, TP8, TP9, TP10, TP11, TP12, TP13, TP16, TP17, TP18, TP19, TP20, TP21, TP22, TP23, TP25, TP26	Test point, white, 0.062 in. Hole, 5012, TH	5012	Keystone
6	TP3, TP6, TP14, TP15, TP24, TP27	Test point, black, 0.062 in. Hole, 5011, TH	5011	Keystone
1	U1	AdvancedMC Slot Controller, QFN-32	TPS2458RHB**	Texas Instruments
1	N/A	PCB, FR-4, 4 layer, SMOBC, 4.62" x 4.00" x .062"	HPA402**	Any
8	N/A	Shunt, open top	151-8000	Kobiconn
4	N/A	Spacer, nylon, hex, #6-32, 0.625"	14HTSP020	Eagle
4	N/A	Screw, nylon, round head, #6-32, 0.25"	010632R025	Eagle

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### EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range of 3.0 V to 12 V and the output voltage range of 3.0 V to 12 V .

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 85°C. The EVM is designed to operate properly with certain components above as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>
Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>
RFID	<a href="http://www.ti-rfid.com">www.ti-rfid.com</a>
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